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01-30-2002

To. <u>JP920010088US1</u>

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Please record the accaded original documents or copy thereof. 2. Name and address of receiving Name of conveying party(ies): party(ies): VIKAS AGARWAL, GIRISH CHAFLE, Name: International Business NEERAN MOHAN KARNIK, ARUN KUMAR, Machines Corporation ASHISH KUNDU, JOHARA SHAHABUDDIN, Address: New Orchard Road PRADEEP VARMA Armonk, NY 10504 Additional name(s) of conveying Additional name(s) & addresses party(ies) attached? Yes X No attached? ____Yes X No 4. Patent Application number(s) 3. Nature of conveyance: X Assignment 09/921,868 Execution Date(s): July 25, 2001, Execution Date(s): __July 25, 2001, July 25, 2001, July 25, 2001 6. Total number of applications 5. Name and address of party to involved: whom correspondence concerning document should be mailed: 7. Total fee (37 CFR 3.41): \$40.00 STEPHEN C. KAUFMAN Name: Address: IBM Corporation Intellectual Property Law X Charge to Deposit Account No.: 09-0468 P.O. Box 218 Yorktown Heights, NY 10598 DO NOT USE THIS SPACE 8. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of original domument. MANNY W. SCHECTER (Reg. No. 31,722) Signature Name of Person Signing Total Number of pages including cover sheet, attachments, and document: 01/29 2002 SAHMEDI 00000120 030468 09921868 40.00 CH DO NOT DETACH THIS PORTION :581 Mail documents to be recorded with required cover sheet information to: Assistant Commissioner for Patents Box Assignments Washington, DC 20231

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> **PATENT** REEL: 012505 FRAME: 0949

IBM Docket No. JP920010088US1

ASSIGNMENT

Whereas, I/We,

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Pradeep Varma

Of 10 West Avenue, IIT Campus, Hauz Khas New Delhi-110016, India

have invented certain improvements in: Managing Server Resources for Hosted Application

and executed a United States patent application therefor on even date $% \frac{1}{2}\left(\frac{1}{2}\right) =0$

Whereas, INTERNATIONAL BUSINESS MACHINES CORPORATION, a corporation of New York, having a place of business at Armonk, New York 10504, (hereinafter called IBM) desires to acquire the entire right, title and interest in the said application and invention, and

to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, I the above named, hereby sell, assign, and transfer to IBM, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and I request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said application to IBM, its successors and assigns; and I hereby agree that IBM may apply for foreign Letters Patent on said invention and I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by IBM.

Signed and sealed
Signature: Vikas Agarwal Vikas Agarwal
Date: July 25, 2001
Signed and sealed
Signature: G.Bhafle Girish Chafle
Date: July 25, 2001
Signed and sealed
Signature: Neeran Mohan Karnik
Date: July 25, 2001
Signed and sealed
Signature: Arun Kumar
Date: JULY 25,2001
Signed and sealed
Signature: A
Ashish Kundu

Date: JULY 25, 2001

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C	iar	50	and	C 0	37.	50

Signature: Acababadan

Johara Shahabuddin

Date: July 25,2001

Signed and sealed

Signature: Indeep Varma

Date: July 25/201

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